

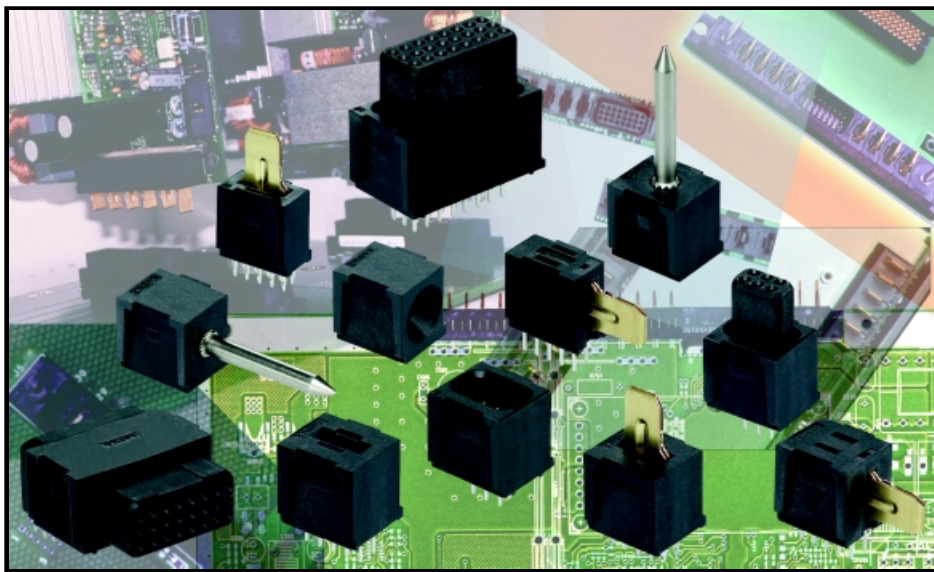
Modular FLATPAQ™

Modular Board-To-Board
Hot Plug High Current Power Connectors

Modular FLATPAQ connectors provide custom solutions to hot pluggable AC and DC power needs in a board-to-board format. By using off-the-shelf modular components, power and signal modules,

guide pins and other available features can be combined in a configuration to meet your exact needs. Simply define which modules are required and in what sequence, using the Layout Sheet

provided, and Elcon will provide samples, typically within one week.



FEATURES

- Custom configurable modular design
- 35A hot pluggable contacts
- Blind-mating
- Sequenced mating for power & signal
- Solder or press-fit terminations
- Active guide pin
- Low insertion force
- Off-the-shelf modular components

APPLICATIONS

- Board-to-board power connections
- Power supplies, UPS
- Telecommunications
- Computers and file servers
- Aerospace power applications

High Current Capabilities



FLATPAQ uses Elcon's highly reliable CROWN BAND technology that guarantees low insertion and extraction forces, minimal voltage drop and reduced temperature rise. Rated at 35A,

FLATPAQ may handle even higher currents when mounted on boards with 5 oz. copper traces or onto a busbar (see Test Data on last page).

Guide Pins

FLATPAQ guide modules, both passive and active (for premate ground), are offered to provide increased gatherability for aligning connectors during blind mating.

Contact Termination Options

FLATPAQ offers a variety of contact terminations for mounting to printed circuit boards, such as compliant press-fit, solder tail length options, and a retentive feature that holds the connector in place prior to soldering.

Sequenced Mating

Power blades are available in standard, postmate and premate lengths, allowing mating sequences suited to any design requirement. Signal contacts are available in standard and premate lengths.⁽¹⁾

Regulatory Agency Evaluations

Modular FLATPAQ has been evaluated by Underwriters Laboratories Inc. to the U.S. standard UL1977 (USR); by UL (CNR) and CSA to the Canadian standard C22.2 No. 182.3-M1987 for use in data, signal, control and power applications; and by TÜV to the European standard EN60950.⁽²⁾



FLATPAQ Connector Layout

FAX TO ELCON AT (510) 490-3740

Use this sheet to specify the desired connector layout. Please copy this sheet prior to completion to allow reuse.

INSTRUCTIONS

- Indicate the connector layout by filling in the FP number of each module required in the boxes below, one per box. Use one form per mated pair.
- The left to right order of the modules should match the **mating face views** of the connector. **When laying out right angle assemblies**, make sure that you look at the mating face with the termination tails facing downwards.
- For **solder terminated assemblies**, indicate the tail length for each half of the connector and whether the retentive feature is required using the checkboxes to the right of the layout grid.

Upon receipt of this form, Elcon will generate a Customer Use Drawing for you to check and approve prior to connector production.

Write the "FP" numbers to indicate the layout of one half of the connector assembly, matching the left to right order with the mating face view of the connector (right angle assembly tails facing downwards).

FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	Solder tail options	
														<input type="checkbox"/> .062" thick board	<input type="checkbox"/> .125" thick board
														<input type="checkbox"/> .093" thick board	<input type="checkbox"/> Retentive feature

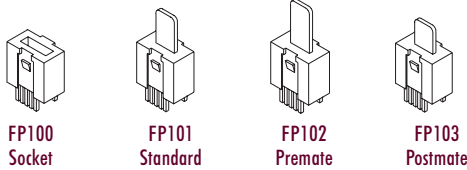
Write the "FP" numbers to indicate the layout of the mate to the above assembly, matching the left to right order with the mating face view of the connector (right angle assembly tails facing downwards).

FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	FP	Solder tail options	
														<input type="checkbox"/> .062" thick board	<input type="checkbox"/> .125" thick board
														<input type="checkbox"/> .093" thick board	<input type="checkbox"/> Retentive feature

SOLDER TERMINATED MODULES

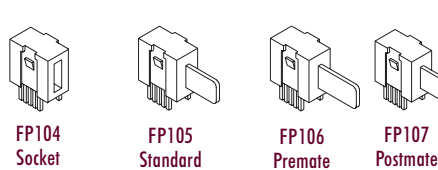
STRAIGHT TAILS

250V Power Modules

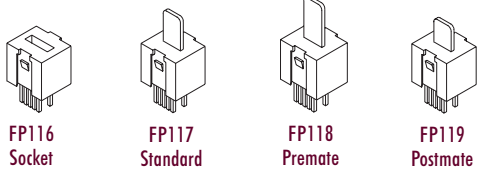


RIGHT ANGLE TAILS

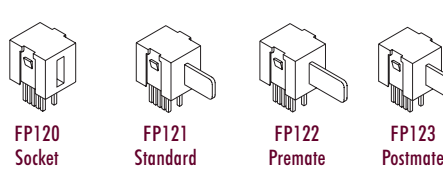
250V Power Modules



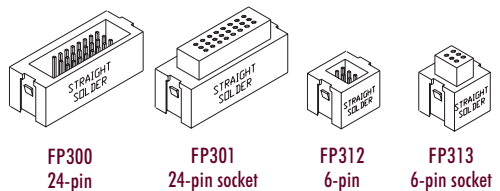
600V Power Modules



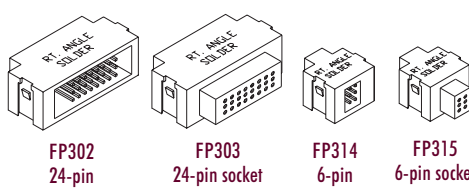
600V Power Modules



Signal Modules



Signal Modules



SOLDER TAIL OPTIONS

The following options are available when specifying solder terminated assemblies. Indicate these options by marking the check-boxes to the right of the connector layout grid.

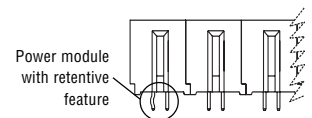
■ Tail length

Solder tails are available in 3 lengths. Select depending on board thickness and mounting style (straight or right angle assembly). See table below or, for more details, refer to TERMINATION OPTIONS at the bottom of next page.

Board Thickness	Straight Tails	Right Angle Tails
.062"	.115" (2.92mm) Nominal	.115" (2.92mm) Nominal
.093"	.143" (3.6mm) Nominal	.177" (4.5mm) Nominal
.125"	.177" (4.5mm) Nominal	.177" (4.5mm) Nominal

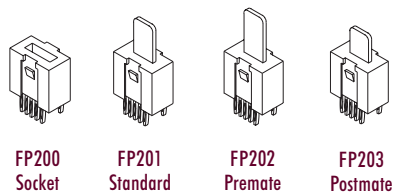
■ Retentive feature

Consists of precisely formed solder tails on the contacts of the outermost power modules of the assembly, as shown in the drawing below.

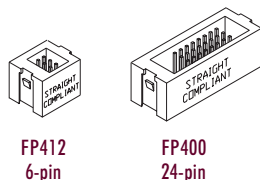


PRESS-FIT TERMINATED MODULES For 0.093" or thicker boards

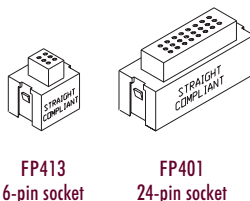
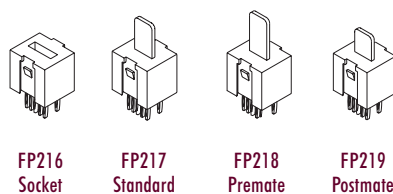
250V Power Modules



Signal Modules



600V Power Modules



OTHER MODULES

Mounts



FP500 Left flange mount



FP501 Right flange mount

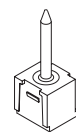
Guides



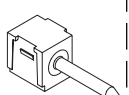
FP502 Straight passive guide socket



Right angle guide sockets
FP506 Passive
FP516 Active



Straight guide pins
FP503 Passive
FP515 Active, M3
FP517 Active, 4-40



FP507 Right angle passive guide pin

Spacers (without contacts)



FP511 Straight 250V spacer



FP512 Right angle 250V spacer



FP513 Straight 600V spacer



FP514 Right angle 600V spacer

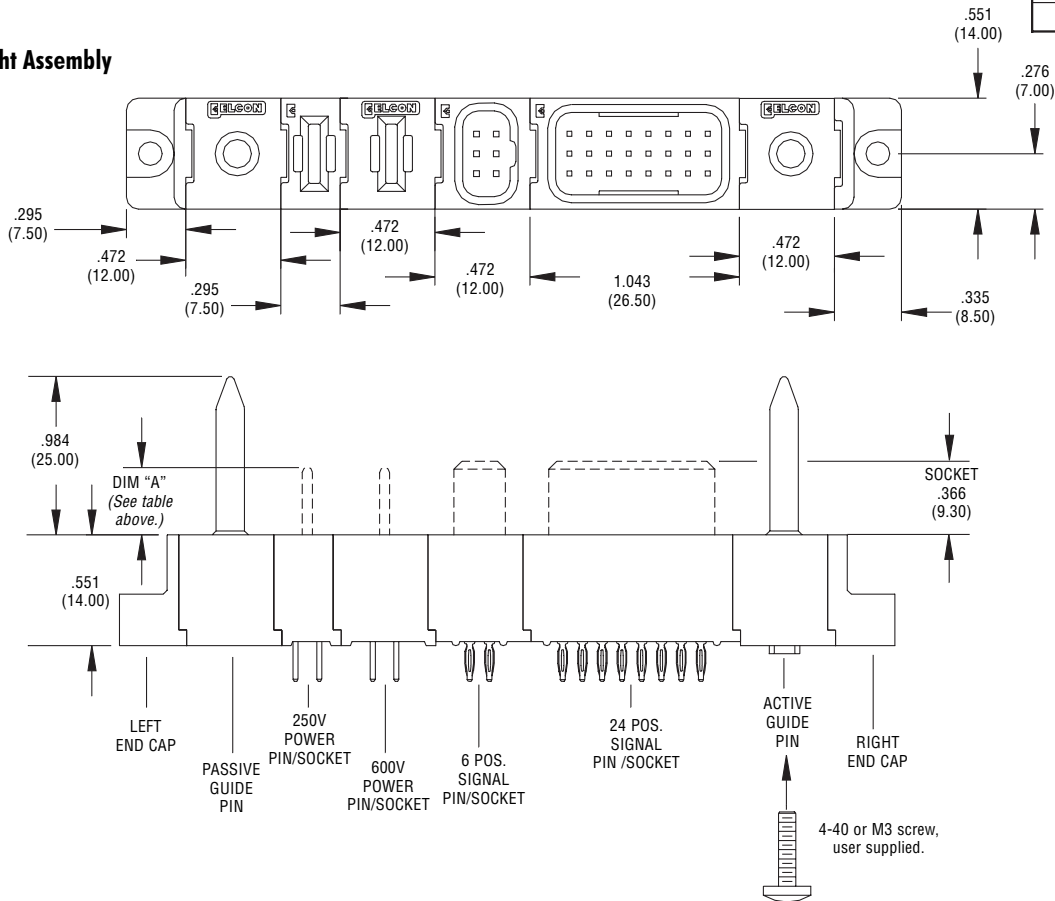
DIMENSIONS

The drawings below show module dimensions for one of the countless layouts possible with Modular FLATPAQ. These drawings are for reference only. To do actual engineering design work, request a Customer User Drawing (CUD) from Elcon for your particular module configuration.

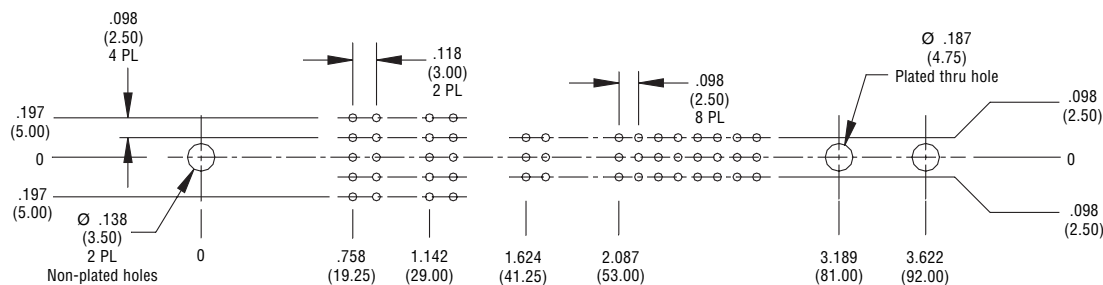
Power Blade Length

Blade Type	Dimension "A"	
	Inches	mm
Premate	.492	12.50
Standard	.413	10.50
Postmate	.335	8.50

Straight Assembly



PC Board Footprint

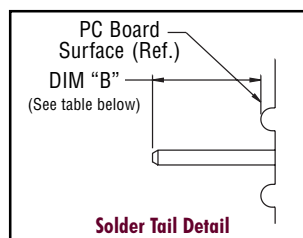


Dimensions, specifications and product external appearance subject to change without notice.

TERMINATION OPTIONS

Solder termination

Solder termination is available in three lengths for straight connectors, and in two lengths for right-angle assemblies. Please refer to the table below for board thicknesses and recommended tail lengths.

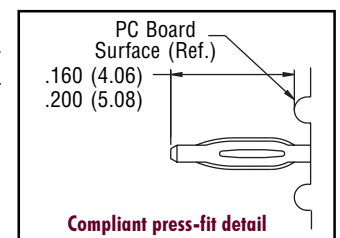


Compliant press-fit termination

Compliant press-fit termination is available for straight assemblies only, and it is designed for use with boards 0.093" thick and above.

Tooling for compliant press-fit assemblies

Press plates are recommended for compliant press-fit assemblies. Elcon will provide details of the recommended tooling fixture for each assembly.



Relationship between tail length and board thicknesses

Board Thickness	Dimension "B"	
	Straight Mounting	Right Angle Mounting
.062"	.100" - .140" (2.55 - 3.57mm) [.115" (2.92mm) nominal]	.100" - .140" (2.55 - 3.57mm) [.115" (2.92mm) nominal]
.093"	.130" - .170" (3.30 - 4.32 mm) [.143" (3.6mm) nominal]	.160" - .200" (4.06 - 5.08mm) [1.77" (4.5mm) nominal]
.125"	.160" - .200" (4.06 - 5.08mm) [1.77" (4.5mm) nominal]	.160" - .200" (4.06 - 5.08mm) [1.77" (4.5mm) nominal]

Insertion & extraction forces of compliant modules

Forces: Tested per MIL-C-28859 (reference only)
 Push In: 11.2 - 22.5 lbs. per pin (50 - 100N)
 Push Out: 10.1 - 20.2 lbs. per pin (45 - 90N)

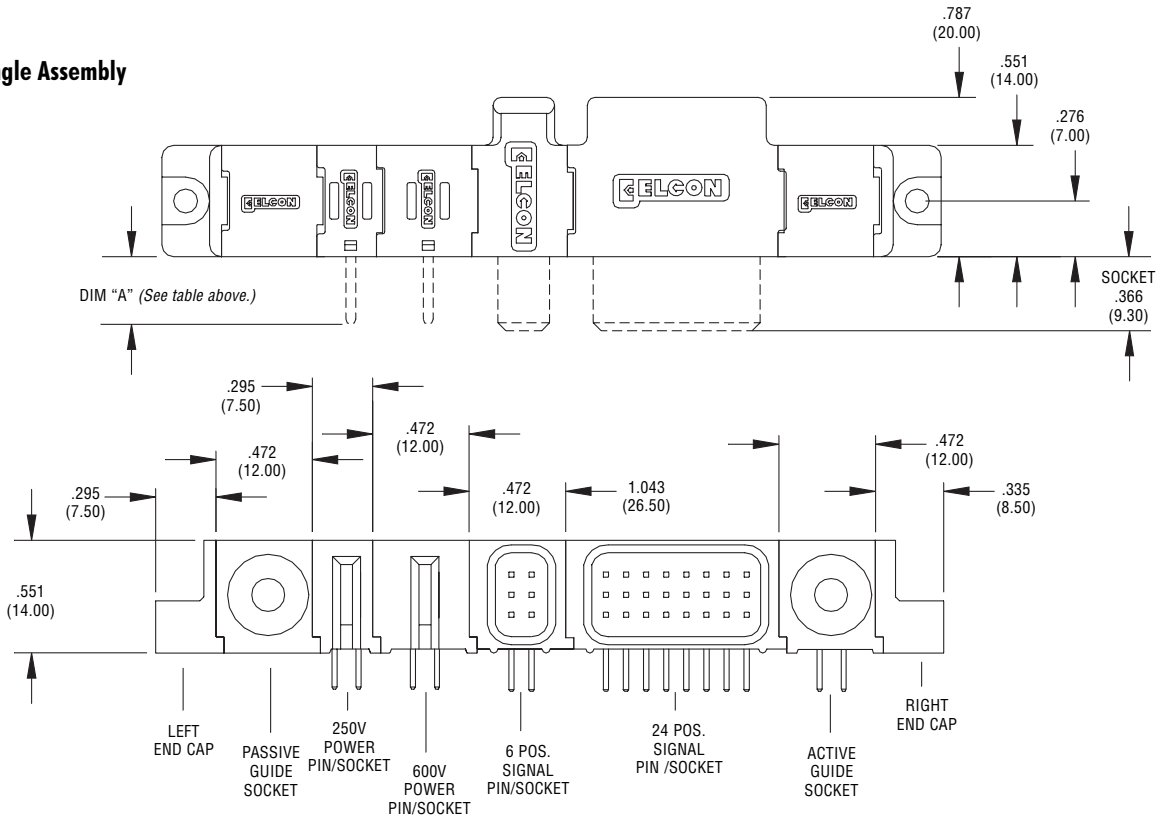
■ DIMENSIONS

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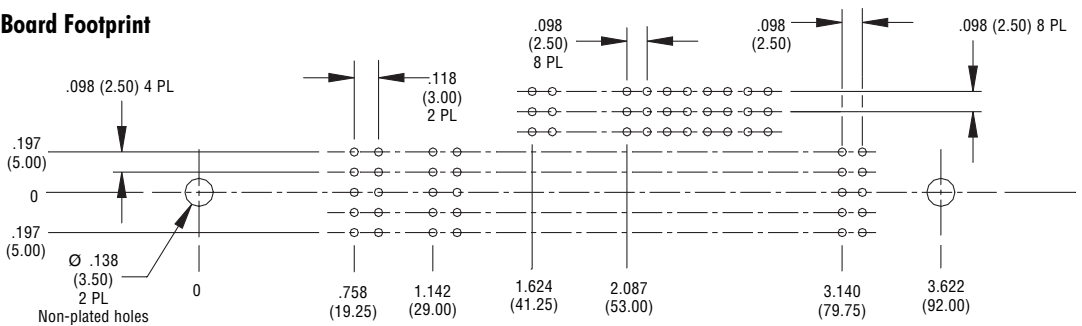
Power Blade Length

Blade Type	Dimension "A"	
	Inches	mm
Premate	.492	12.50
Standard	.413	10.50
Postmate	.335	8.50

Right Angle Assembly

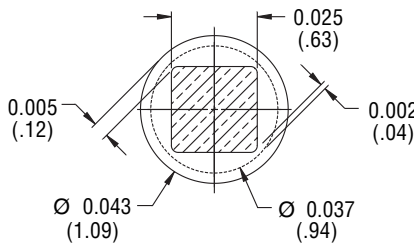


PC Board Footprint



Dimensions, specifications and product external appearance subject to change without notice.

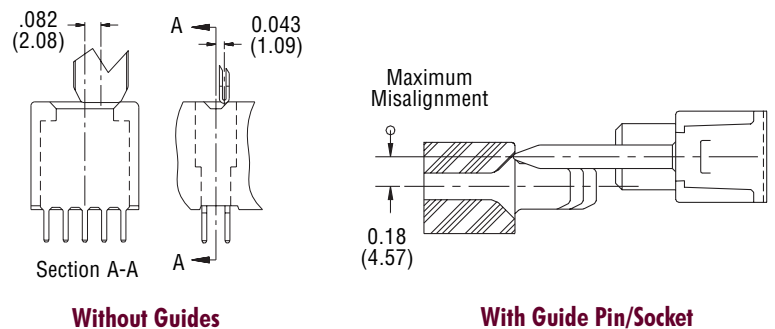
■ SUGGESTED PRINTED CIRCUIT HOLE



Solder and compliant press-fit termination area

- Finished Hole: $\varnothing 0.040 \pm .0030$ ($\varnothing 1.02 \pm .08$)
- Drilled Hole: $\varnothing 0.0453 \pm .0005$ ($\varnothing 1.15 \pm .013$)
- Copper Plate: .0010 (.025) min. (per surface)
- Tin Plate: .0003 (.008) min. (per surface)

■ BLIND MATING ALIGNMENT



Without Guides

With Guide Pin/Socket

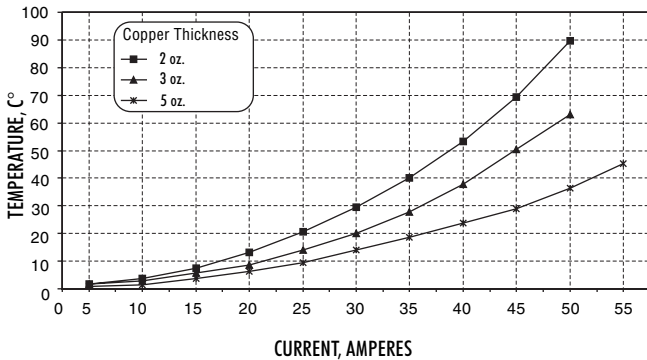
Product Specifications

MATERIALS			
Insulators		PPA, UL 94-V-0 flammability rated, color black	
Signal Contacts		Solder termination brass alloy per ASTM-B-36; compliant termination phosphor bronze alloy per ASTM-B-103, selectively plated with gold per MIL-G-45204, Type II, Grade C, Class 0 (30µin minimum) and bright tin/lead per MIL-T-10727, Type 1 (100µin minimum) on terminations, all over nickel per QQ-N-290, Class 2 (50µin minimum)	
Crown Bands		Beryllium copper alloy per ASTM-B-194, selectively plated with gold per MIL-G-45204, Type II, Grade C, Class 0 (30µin minimum), over nickel per QQ-N-290, Class 2 (50µin minimum)	
Power Socket Contacts		Phospor bronze alloy per ASTM-B-103, selectively plated with bright tin/lead per MIL-T-10727, Type 1 (100µin minimum) on terminations, over nickel per QQ-N-290	
Power Blade Contacts		Copper alloy per ASTM-B-152, selectively plated with gold per MIL-G-45204, Type II, Grade C, Class 0 (30µin minimum), over nickel per QQ-N-290, Class 2 (50µin minimum)	
Other Modules	Passive Guide Pin	Brass alloy per ASTM-16 plated with nickel per AMS2404	
	Activated Guide Pin	Tellurium copper alloy per ASTM-B-301, plated with silver per QQ-S-365	
	Activated Guide Socket Contact	Phosphor bronze per ASTM-B-103, plated with silver per QQ-S-365	
ELECTRICAL			
Regulatory Agency Ratings	Power Contact	UL/TÜV	35A at 250V (50 cycles, hot plug module)
		CUR/GSA	20A at 250V (50 cycles, hot plug module)
	Signal Contact	UL/TÜV	3A
		CUR/GSA	2.5A
Contact Resistance	Power Contact	2mΩ maximum initial, (3mΩ maximum after 500 cycles durability), at 35A per MIL-STD 1344, Method 3004	
	Signal Contact	15mΩ maximum initial, (30mΩ maximum after 500 cycles durability), at 100mA, 20mV, per MIL-STD 1344, Method 3002	
Insulation Resistance	Power Contact	5,000MΩ minimum at 500VDC for 2 minutes, per MIL-STD 1344, Method 3003	
	Signal Contact		
Dielectric Strength	Power Contact	1,500VDC for 1 minute, per MIL-STD 1344, Method 3001	
	Signal Contact		
MECHANICAL			
Insertion Force	Power Contact	4.0lbf maximum	
	Signal Contact	5.0ozf maximum using .0305" (.775mm) diameter steel test pin	
Extraction Force	Power Contact	1.0lbf minimum	
	Signal Contact	0.5ozf minimum using .0295" (.749mm) diameter steel test pin	
Durability	Power Contact	500 cycles, per MIL-STD-1344, Method 2016	
	Signal Contact		
Contact Retention	Power Contact	10.0lbf minimum	
	Signal Contact	5.0lbf minimum	
Tooling		Press fixture is recommended for compliant press fit assemblies Consult ELCON for details.	
Marking		Connectors are marked with manufacturer's logo, part number and lot code.	
ENVIRONMENTAL			
Temperature Rating		-40°C to +105°C	
Vibration		MIL-STD 1344, Method 2005, Test Condition II	
Shock		MIL-STD 1344, Method 2004, Test Condition I	
Humidity		MIL-STD 1344, Method 1002, Type 1, Test Condition B	
Temperature Life		MIL-STD 1344, Method 1005, Test Condition 4D (105 ±2°C, 1,000 hours)	
Solderability		MIL-STD 202, Method 208	

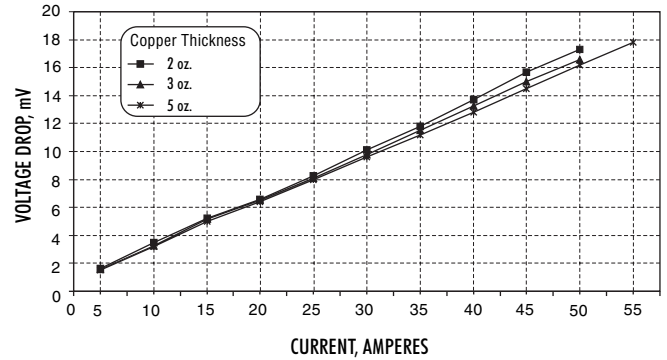
Test Data

The two graphs below show the performance of Modular FLATPAQ in terms of temperature rise and voltage drop against current. Both tests were performed on 250V power modules mounted on PC boards with 2 oz., 3 oz. and 5 oz. copper traces.

TEMPERATURE RISE



VOLTAGE DROP



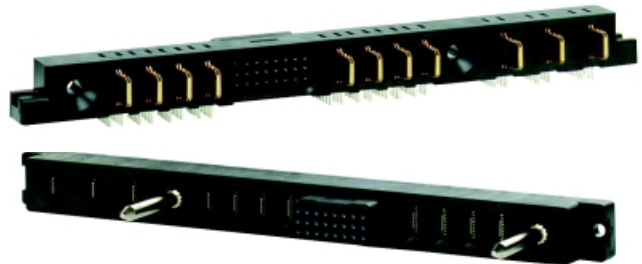
Dedicated FLATPAQ

Popular configurations are available as premolded FLATPAQ connectors. Elcon will automatically suggest the optimum solution for your application from all currently tooled insulators. For more information, request Dedicated FLATPAQ product literature from Elcon.



SERVERPAK

Cost-effective FLATPAQ specifically designed for high-end PC servers. SERVERPAK features 8 power and 24 signal contacts in less than 3.5" (90 mm) of length.



Dedicated FLATPAQ

This is one of the many dedicated FLATPAQ connectors that replicate the modular FLATPAQ, resulting in a more cost effective solution.